



SYNCHRONOUS DRAM

MT48LC8M16A2 – 2 MEG X 16 X 4 BANKS

For the latest data sheet, please refer to the Micron Web site: www.micron.com/dramds

FEATURES

- Supports PC100 and PC133 functionality
- Fully synchronous; all signals registered on positive edge of system clock
- Internal pipelined operation; column address can be changed every clock cycle
- Internal banks for hiding row access/precharge
- Programmable burst lengths: 1, 2, 4, 8, or full page
- Auto Precharge, includes CONCURRENT AUTO PRECHARGE, and Auto Refresh Modes
- Self Refresh Mode; standard and low power
- LVTTTL-compatible inputs and outputs
- Single +3.3V ±0.3V power supply
- 64ms, 4,096-cycle refresh

OPTION

- Configuration
8 Meg x 16 (2 Meg x 16 x 4 banks)
WRITE Recovery (^tWR)
^tWR = "2 CLK"¹
- Package
Plastic Package – OCPL²
54-pin TSOP II (400 mil)
- Timing (Cycle Time)
6.0ns @ CL = 3
- Self Refresh
Standard
- Operating Temperature Range
Commercial (0°C to +70°C)

MARKING

8M16
A2

TG

-6A

None

None

ADDENDUM CHANGES

The standard 128Mb SDRAM data sheets also pertain to the x16 device and should be referenced for a complete description of SDRAM functionality and operating modes. However, to meet the faster speed grades, some of the AC timing parameters are slightly different. This addendum data sheet will concentrate on the key differences required to support the enhanced speeds.

The Micron 128Mb data sheet provides full specifications and functionality unless specified herein.

	8 MEG X 16
Configuration	2 Meg x 16 x 4 banks
Refresh Count	4K
Row Addressing	4K (A0–A11)
Bank Addressing	4 (BA0, BA1)
Column Addressing	512 (A0–A8)

KEY TIMING PARAMETERS

SPEED GRADE	CLOCK FREQUENCY	ACCESS TIME CL = 3*	SETUP TIME	HOLD TIME
-6A	167 MHz	5.4ns	1.5ns	0.8ns

NOTE:

1. Refer to Micron Technical Note: TN-48-05.
2. Off-center parting line.

Part Number:

MT48LC8M16A2TG-6A



IDD SPECIFICATIONS AND CONDITIONS

Notes: 1, 5, 6, 11, 13; notes appear in the standard data sheet; $V_{DD}/V_{DDQ} = +3.3V \pm 0.3V$

PARAMETER/CONDITION	SYMBOL	-6A	UNITS	NOTES	
Operating Current: Active Mode; Burst = 2; READ or WRITE; $t_{RC} = t_{RC}(\text{MIN})$	IDD1	170	mA	3, 18, 19, 32	
Standby Current: Power-Down Mode; All banks idle; CKE = LOW	IDD2	2	mA	32	
Standby Current: Active Mode; CKE = HIGH; CS# = HIGH; All banks active after t_{RCD} met; No accesses in progress	IDD3	50	mA	3, 12, 19, 32	
Operating Current: Burst Mode; Continuous burst; READ or WRITE; All banks active	IDD4	165	mA	3, 18, 19, 32	
Auto Refresh Current CKE = HIGH; CS# = HIGH	$t_{RFC} = t_{RFC}(\text{MIN})$	IDD5	330	mA	3, 12, 18, 19, 32, 33
	$t_{RFC} = 15.625\mu\text{s}$	IDD6	3	mA	
Self Refresh Current: CKE $\leq 0.2V$	Standard	IDD7	2	mA	4



ELECTRICAL CHARACTERISTICS AND RECOMMENDED AC OPERATING CONDITIONS

Notes 5, 6, 8, 9,11; Notes appear on in the standard data sheet

AC CHARACTERISTICS			-6A			
PARAMETER		SYMBOL	MIN	MAX	UNITS	NOTES
Access time from CLK (pos. edge)	CL = 3	$t_{AC(3)}$		5.4	ns	27
Address hold time		t_{AH}	0.8		ns	
Address setup time		t_{AS}	1.5		ns	
CLK high-level width		t_{CH}	2.5		ns	
CLK low-level width		t_{CL}	2.5		ns	
Clock cycle time	CL = 3	$t_{CK(3)}$	6		ns	23
CKE hold time		t_{CKH}	0.8		ns	
CKE setup time		t_{CKS}	1.5		ns	
CS#, RAS#, CAS#, WE#, DQM hold time		t_{CMH}	0.8		ns	
CS#, RAS#, CAS#, WE#, DQM setup time		t_{CMS}	1.5		ns	
Data-in hold time		t_{DH}	0.8		ns	
Data-in setup time		t_{DS}	1.5		ns	
Data-out high-impedance time	CL = 3	$t_{HZ(3)}$		5.4	ns	10
Data-out low-impedance time		t_{LZ}	1		ns	
Data-out hold time (load)		t_{OH}	3		ns	
Data-out hold time (no load)		t_{OH_N}	1.8		ns	28
ACTIVE to PRECHARGE command		t_{RAS}	42	120,000	ns	
ACTIVE to ACTIVE command period		t_{RC}	60		ns	
ACTIVE to READ or WRITE delay		t_{RCD}	18		ns	
Refresh period (4,096 rows)		t_{REF}		64	ms	
AUTO REFRESH period		t_{RFC}	60		ns	
PRECHARGE command period		t_{RP}	18		ns	
ACTIVE bank a to ACTIVE bank b command		t_{RRD}	12		ns	7
Transition time		t_T	0.3	1.2	ns	
WRITE recovery time ¹		t_{WR}	1 CLK + 6ns		ns	
			12		ns	25
Exit SELF REFRESH to ACTIVE command		t_{XSR}	67		ns	20

NOTE:

1. Auto precharge mode only. The precharge timing budget (t_{RP}) begins 6ns for -6A after the first clock delay, after the last WRITE is executed. May not exceed limit set for precharge mode.



AC FUNCTIONAL CHARACTERISTICS

Notes appear in the standard data sheet.

PARAMETER	SYMBOL	-6A SPEED	UNITS	NOTES
READ/WRITE command to READ/WRITE command	t_{CCD}	1	t_{CK}	17
CKE to clock disable or power-down entry mode	t_{CKED}	1	t_{CK}	14
CKE to clock enable or power-down exit setup mode	t_{PED}	1	t_{CK}	14
DQM to input data delay	t_{DQD}	0	t_{CK}	17
DQM to data mask during WRITES	t_{DQM}	0	t_{CK}	17
DQM to data high-impedance during READS	t_{DOZ}	2	t_{CK}	17
WRITE command to input data delay	t_{DWD}	0	t_{CK}	17
Data-in to ACTIVE command	t_{DAL}	5	t_{CK}	15, 21 ¹
Data-in to PRECHARGE command	t_{DPL}	2	t_{CK}	16, 21
Last data-in to burst STOP command	t_{BDL}	1	t_{CK}	17
Last data-in to new READ/WRITE command	t_{CDL}	1	t_{CK}	17
Last data-in to PRECHARGE command	t_{RDL}	2	t_{CK}	16, 21
LOAD MODE REGISTER command to ACTIVE or REFRESH command	t_{MRD}	2	t_{CK}	26
Data-out to high-impedance from PRECHARGE command (CL=3)	$t_{ROH(3)}$	3	t_{CK}	17

NOTE:

1. The Note 21 in the standard data sheet does not apply for this speed grade and should read "Based on $t_{CK} = 6ns$ "

DATA SHEET DESIGNATION

Preliminary: This data sheet contains initial characterization limits that are subject to change upon full characterization of production devices.



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